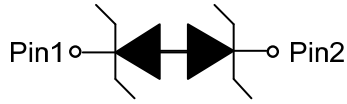


1- Line, Bi-directional, Transient Voltage Suppressor



SOD-523

Features

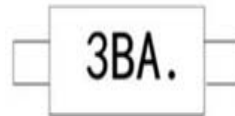
- Stand-off voltage: 3.3V Max
- Transient protection for each line according to IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 18A (8/20 μs)
- Low leakage current
- Ultra low clamping voltage
- RoHS Compliant

Applications

- Cellular handsets
- Tablets
- Laptops
- Other portable devices
- Network communication devices

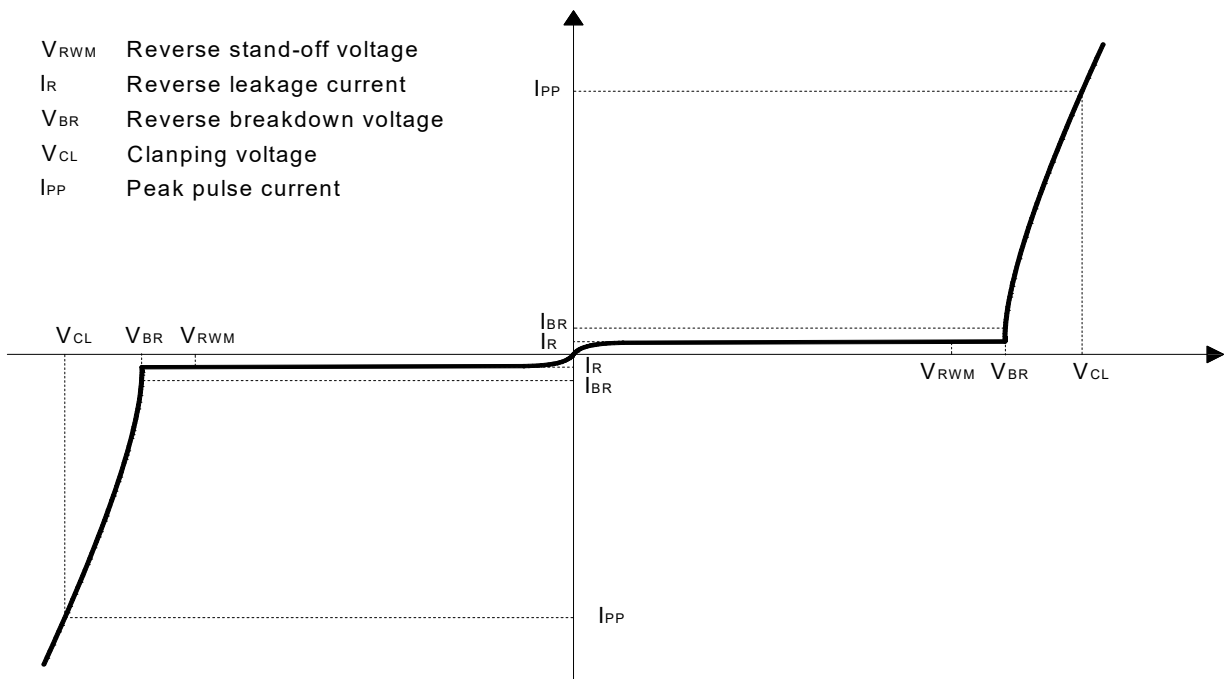
Mechanical Data

- Package: SOD-523
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics

- V_{RWM} Reverse stand-off voltage
 I_R Reverse leakage current
 V_{BR} Reverse breakdown voltage
 V_{CL} Clamping voltage
 I_{PP} Peak pulse current





ESD3V3D5BA1

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	180	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	18	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	-45~125	°C
Storage temperature	T_{STG}	-55~150	°C

■Electrical Characteristics ($T_a=25^\circ C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				3.3
Reverse leakage current	I_R	μA	$V_{RWM} = 3.3V$			0.5
Reverse breakdown voltage	V_{BR}	V	$I_{BR} = 1mA$	3.7		
Clamping voltage ¹⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$			6
		V	$I_{PP} = 18A, t_p = 8/20\mu s$			10
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		45	60

Note:

1. Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5.
2. TLP parameter: $Z_0=50\Omega$, $t_p=100ns$, $t_r=2ns$, averaging window from 60ns to 80ns. RDYN is calculated from 4A to 16A.

■Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD3V3D5BA1	F2	Approximate 2	8000	80000	320000	7" reel



■ Characteristics (Typical)

Fig.1 8/20 μ s waveform per IEC61000-4-5

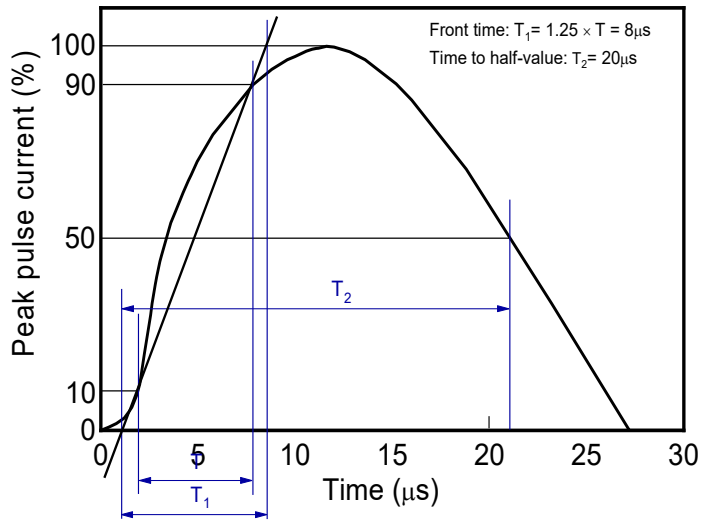


Fig.3 Clamping voltage vs. Peak pulse current

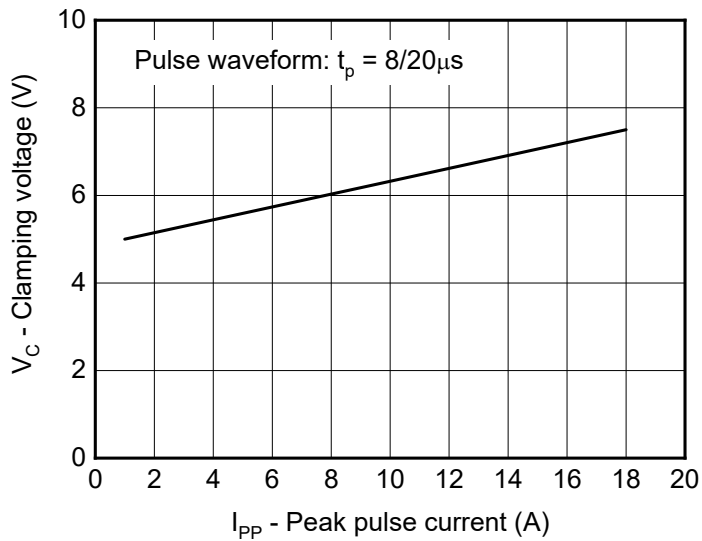


Fig.5 Non-repetitive peak pulse power vs. Pulse time

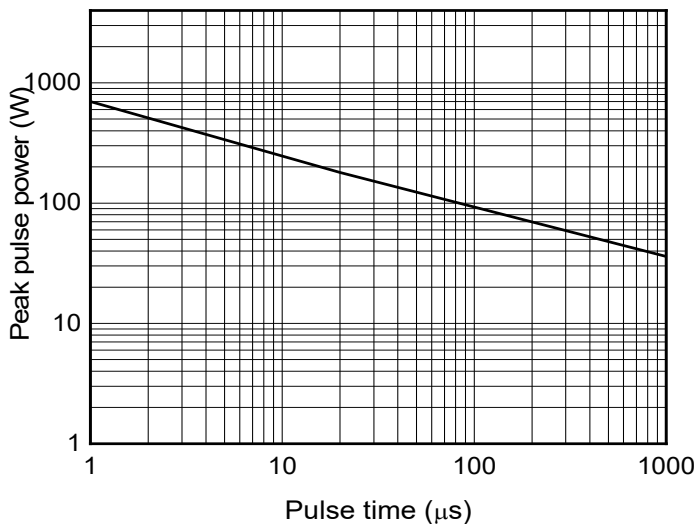


Fig.2 Contact discharge current waveform per IEC61000-4-2

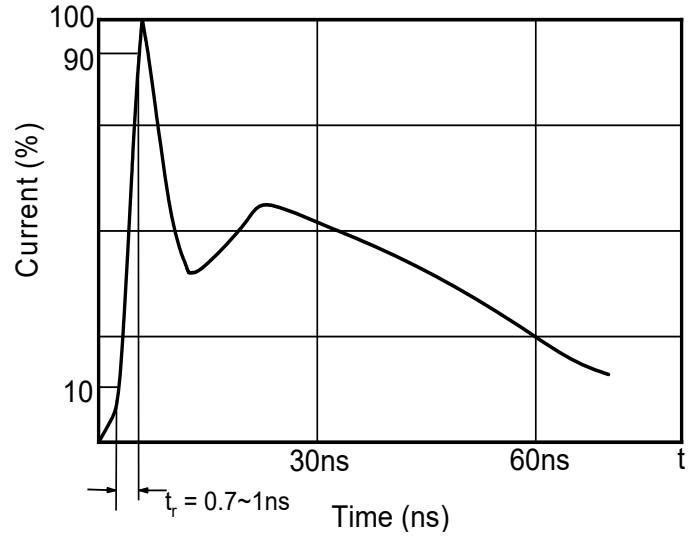


Fig.4 Capacitance vs. Reverse voltage

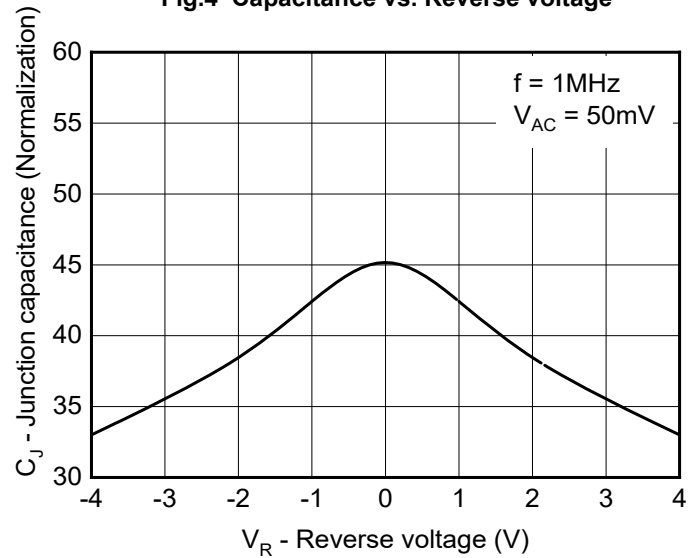


Fig.6 Power derating vs. Ambient temperature

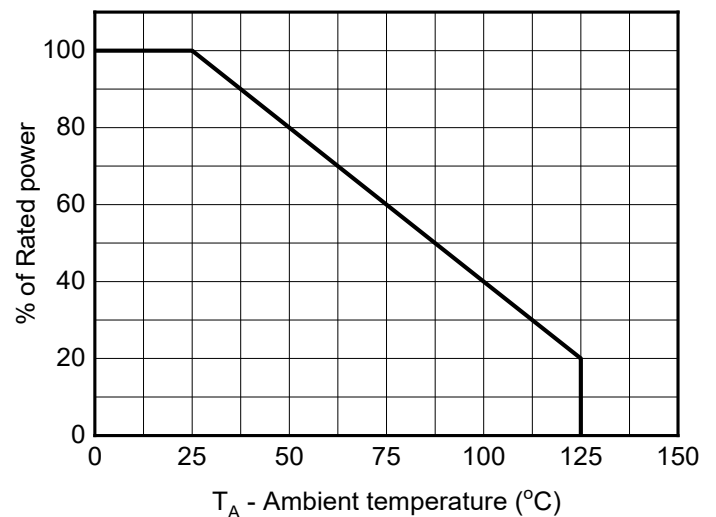
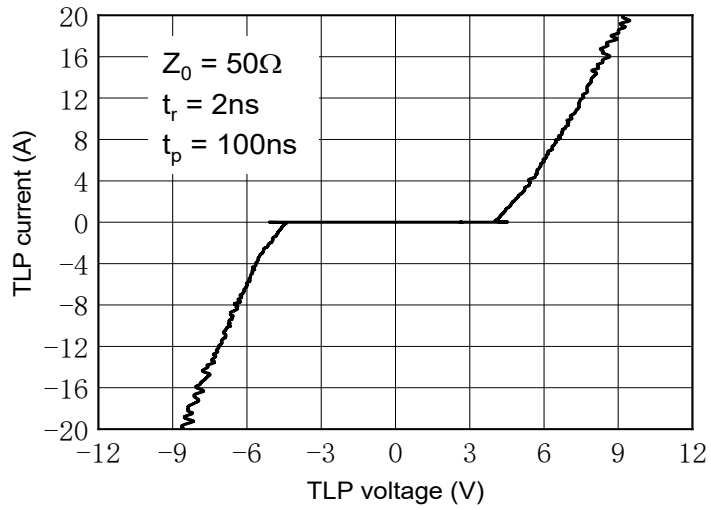




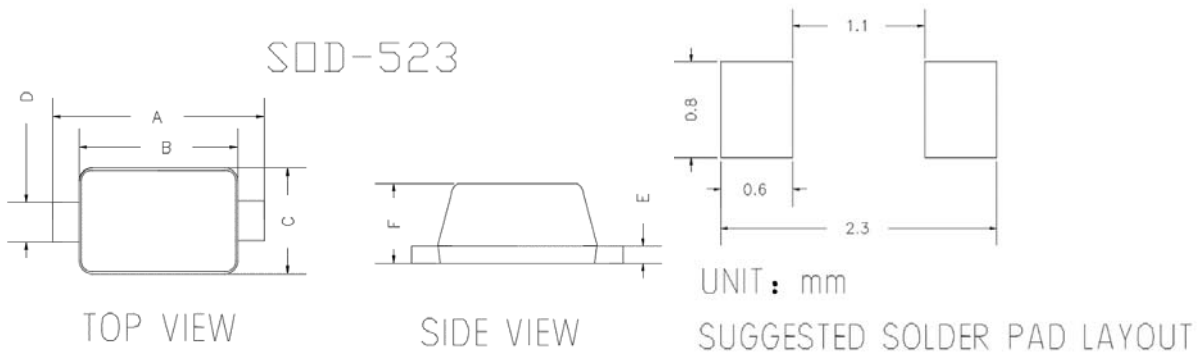
Fig.7 TLP Measurement





ESD3V3D5BA1

■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.059	0.067	1.500	1.700
B	0.043	0.051	1.100	1.300
C	0.028	0.035	0.700	0.900
D	0.010	0.014	0.250	0.350
E	0.002	0.008	0.050	0.200
F	0.020	0.028	0.500	0.700

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.



ESD3V3D5BA1

Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website [http:// www.21yangjie.com](http://www.21yangjie.com) , or consult your nearest Yangjie's sales office for further assistance.